

September 2001

IGRT

FMG2G50US60

Molding Type Module

General Description

Fairchild's Insulated Gate Bipolar Transistor (IGBT) power modules provide low conduction and switching losses as well as short circuit ruggedness. They are designed for applications such as motor control, uninterrupted power supplies (UPS) and general inverters where short circuit ruggedness is a required feature.

Features

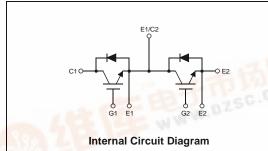
- UL Certified No. E209204
- Short Circuit rated 10us @ $T_C = 100$ °C, $V_{GE} = 15$ V
- High Speed Switching
- Low Saturation Voltage: V_{CE(sat)} = 2.2 V @ I_C = 50A
- High Input Impedance
- Fast & Soft Anti-Parallel FWD

Application

- AC & DC Motor Controls
- General Purpose Inverters
- Robotics
- Servo Controls
- UPS



Package Code: 7PM-GA



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Description		FMG2G50US60	Units
V _{CES}	Collector-Emitter Voltage		600	V
V _{GES}	Gate-Emitter Voltage		± 20	V
I _C	Collector Current	@ T _C = 25°C	50	Α
I _{CM (1)}	Pulsed Collector Current		100	A
I _F	Diode Continuous Forward Current	@ T _C = 100°C	50	Α
I _{FM}	Diode Maximum Forward Current		100	Α
T _{SC}	Short Circuit Withstand Time	@ T _C = 100°C	10	us
P_{D}	Maximum Power Dissipation	@ $T_C = 25^{\circ}C$	250	W
T_J	Operating Junction Temperature		-40 to +150	°C
T _{stg}	Storage Temperature Range		-40 to +125	°C
V _{iso}	Isolation Voltage	@ AC 1minute	2500	V
Mounting	Power Terminals Screw : M5		2.0	N.m
Torque	Mounting Screw : M5		2.0	N.m

Notes :

(1) Repetitive rating: Pulse width limited by max. junction temperature

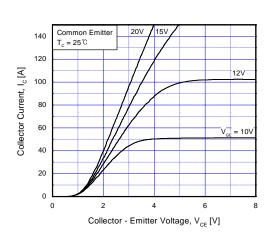
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Cha	racteristics					
BV _{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250uA$	600			V
$\Delta B_{VCES}/$ ΔT_J	Temperature Coeff. of Breakdown Voltage	$V_{GE} = 0V$, $I_C = 1mA$		0.6		V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$			250	uA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$			± 100	nA
On Cha	racteristics					
$V_{GE(th)}$	G-E Threshold Voltage	$V_{GE} = 0V$, $I_C = 50mA$	5.0	6.0	8.5	٧
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C = 50A, V_{GE} = 15V$		2.2	2.8	V
	c Characteristics				T	
C _{ies}	Input Capacitance	$V_{CE} = 30V_{V_{GE}} = 0V_{V_{GE}}$		3460		pF
C _{oes}	Output Capacitance	f = 1MHz		480		pF
C _{res}	Reverse Transfer Capacitance			140		pF
Switchii	ng Characteristics Turn-On Delay Time			20		ns
t _r	Rise Time			30		ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 300 \text{ V}, I_{C} = 50\text{A},$		60		ns
t _f	Fall Time	$R_{G} = 5.9\Omega, V_{GE} = 15V$		110	200	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 25°C		1.1		mJ
E _{off}	Turn-Off Switching Loss			1.2		mJ
E _{ts}	Total Switching Loss			2.3		mJ
t _{d(on)}	Turn-On Delay Time			20		ns
t _r	Rise Time			30		ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 300 \text{ V}, I_{C} = 50\text{A},$		70		ns
t _f	Fall Time	$R_G = 5.9\Omega, V_{GE} = 15V$		250		ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 125°C		1.2		mJ
E _{off}	Turn-Off Switching Loss			2.4		mJ
E _{ts}	Total Switching Loss			3.6		mJ
	Short Circuit Withstand Time	V _{CC} = 300 V, V _{GE} = 15V @ T _C = 100°C	10			us
^I sc						
	Total Gate Charge			145	210	nC
T _{sc} Q _g Q _{ge}	Total Gate Charge Gate-Emitter Charge	V _{CE} = 300 V, I _C = 50A, V _{GE} = 15V		145 28	210 40	nC nC

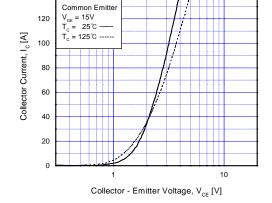
Electrical Characteristics of DIODE $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
V	Diode Forward Voltage	I _F = 50A	$T_C = 25^{\circ}C$		1.9	2.8	V
V_{FM}			T _C = 100°C		1.8		
	t _{rr} Diode Reverse Recovery Time Diode Peak Reverse Recovery Current		$T_C = 25^{\circ}C$		90	130	ns
۲rr			T _C = 100°C		130		
		I _F = 50A	$T_C = 25^{\circ}C$		5	6.5	Α
¹ rr		di / dt = 100 A/us	T _C = 100°C		7		_ ^
Q _{rr}	Diode Reverse Recovery Charge		$T_C = 25^{\circ}C$		225	422	nC
			T _C = 100°C		455		

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case (IGBT Part, per 1/2 Module)		0.5	°C/W
$R_{\theta JC}$	Junction-to-Case (DIODE Part, per 1/2 Module)		1.0	°C/W
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)	0.05		°C/W
Weight	Weight of Module		190	g

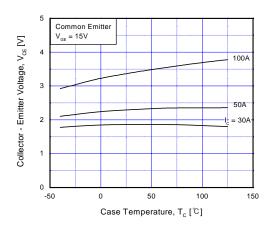




140

Fig 1. Typical Output Characteristics

Fig 2. Typical Saturation Voltage Characteristics



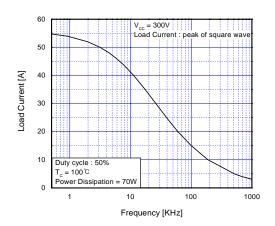
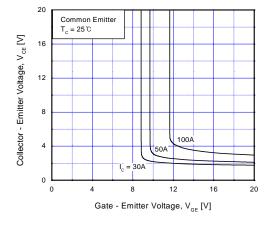


Fig 3. Saturation Voltage vs. Case
Temperature at Variant Current Level

Fig 4. Load Current vs. Frequency



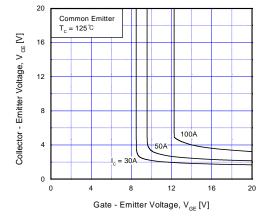
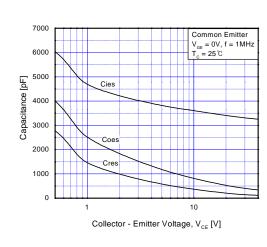


Fig 5. Saturation Voltage vs. V_{GE}

Fig 6. Saturation Voltage vs. V_{GE}

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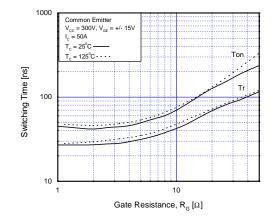
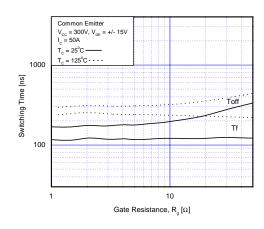


Fig 7. Capacitance Characteristics

Fig 8. Turn-On Characteristics vs.



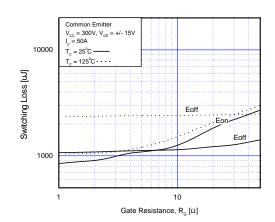
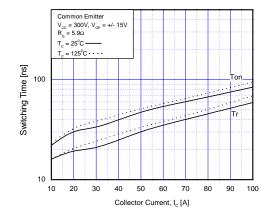


Fig 9. Turn-Off Characteristics vs. Gate Resistance

Fig 10. Switching Loss vs. Gate Resistance



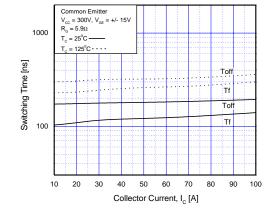
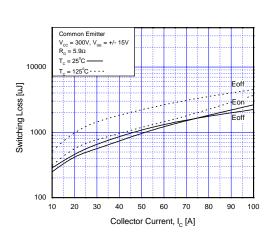


Fig 11. Turn-On Characteristics vs. Collector Current

Fig 12. Turn-Off Characteristics vs. Collector Current

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15 Common Emitter

R_L = 5.9 \(\text{ Common Emitter} \)

R_L = 5.9 \(\text{ Common Emitter} \)

R_L = 25 \(\text{ COMMON Emitter} \)

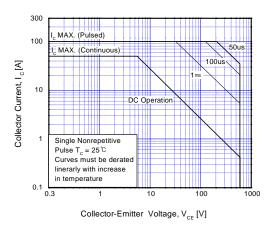
9 9

0 40 80 120 160

Gate Charge, Qg [nC]

Fig 13. Switching Loss vs. Collector Current

Fig 14. Gate Charge Characteristics



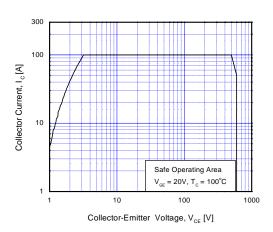
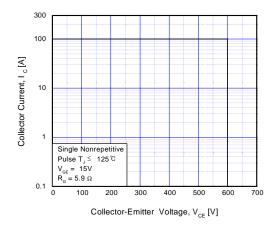


Fig 15. SOA Characteristics

Fig 16. Turn-Off SOA Characteristics



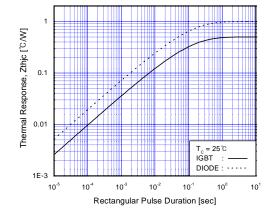
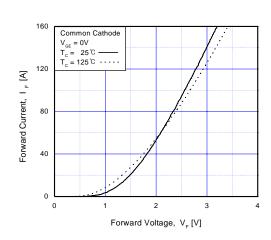


Fig 17. RBSOA Characteristics

Fig 18. Transient Thermal Impedance

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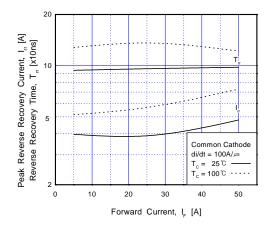


Fig 19. Forward Characteristics

Fig 20. Reverse Recovery Characteristics

Package Dimension 7PM-GA 2-ø5.4±0.3 23±0.5 23±0.5 3-M5 80 ±0.5 16±0.5 16±0.5 16±0.5 28.1±0.5 10±0.5 10±0.5 10±0.5 22.3 -0.6 90±0.5

Dimensions in Millimeters

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